



### **USB3370**

# Enhanced Single Supply Hi-Speed USB ULPI Transceiver





#### **PRODUCT FEATURES**

Data Brief

- USB-IF Battery Charging 1.1 Specification Compliant
- Link Power Management (LPM) Specification Compliant
- Integrated ESD protection circuits
  - Up to ±25kV IEC Air Discharge without external devices
- External VBUS Fault Indicator Input Pin
- Over-Voltage Protection circuit (OVP) protects the VBUS pin from continuous DC voltages up to 30V
- SMSC RapidCharge Anywhere™ Provides:
  - 3-times the charging current through a USB port over traditional solutions
  - USB-IF Battery Charging 1.1 compliance to any portable device
  - Charging current up to 1.5Amps via compatible USB host or dedicated charger
  - Dedicated Charging Port (DCP), Charging (CDP)
     & Standard (SDP) Downstream Port support
- flexPWR<sup>®</sup> Technology
  - Extremely low current design ideal for battery powered applications
  - "Sleep" mode tri-states all ULPI pins and places the part in a low current state
  - 1.8V to 3.3V IO Voltage
- Single Power Supply Operation
  - Integrated 1.8V regulator
  - Integrated 3.3V regulator
    - 100mV dropout voltage
- PHYBoost
  - Programmable USB transceiver drive strength for recovering signal integrity
- VariSense<sup>TM</sup>
  - Programmable USB receiver sensitivity
- "Wrapper-less" design for optimal timing performance and design ease
  - Low Latency Hi-Speed Receiver (43 Hi-Speed clocks Max) allows use of legacy UTMI Links with a ULPI bridge

- External Reference Clock operation available
  - ULPI Clock Input Mode (60MHz sourced by Link)
  - 0 to 3.6V input drive tolerant
  - Able to accept "noisy" clock sources as reference to internal, low-jitter PLL
  - Crystal support available
- Smart detection circuits allow identification of USB charger, headset, or data cable insertion
- Includes full support for the optional On-The-Go (OTG) protocol detailed in the On-The-Go Supplement Revision 2.0 specification
- Supports the OTG Host Negotiation Protocol (HNP) and Session Request Protocol (SRP)
- UART mode for non-USB serial data transfers
- Internal 5V cable short-circuit protection of ID, DP and DM lines to VBUS or ground
- Industrial Operating Temperature -40°C to +85°C
- 32-pin, QFN lead-free RoHS Compliant package (5 x 5x 0.90 mm height)

#### **Applications**

The USB3370 is the solution of choice for any application where a Hi-Speed USB connection is desired and when board space, power, and interface pins must be minimized.

- Cell Phones
- PDAs
- MP3 Players
- GPS Personal Navigation
- Scanners
- External Hard Drives
- Digital Still and Video Cameras
- Portable Media Players
- Entertainment Devices
- Printers
- Set Top Boxes
- Video Record/Playback Systems
- IP and Video Phones
- Gaming Consoles

#### Order Number(s):

ORDER NUMBER	REFCLK FREQUENCY	PACKAGE TYPE	REEL SIZE
USB3370B-EZK-TR	19.2 MHz	32-Pin, QFN Lead-Free RoHS Compliant Package (tape and reel)	4,000 pieces

This product meets the halogen maximum concentration values per IEC61249-2-21 For RoHS compliance and environmental information, please visit www.smsc.com/rohs

Copyright © 2012 SMSC or its subsidiaries. All rights reserved.

Circuit diagrams and other information relating to SMSC products are included as a means of illustrating typical applications. Consequently, complete information sufficient for construction purposes is not necessarily given. Although the information has been checked and is believed to be accurate, no responsibility is assumed for inaccuracies. SMSC reserves the right to make changes to specifications and product descriptions at any time without notice. Contact your local SMSC sales office to obtain the latest specifications before placing your product order. The provision of this information does not convey to the purchaser of the described semiconductor devices any licenses under any patent rights or other intellectual property rights of SMSC or others. All sales are expressly conditional on your agreement to the terms and conditions of the most recently dated version of SMSC's standard Terms of Sale Agreement dated before the date of your order (the "Terms of Sale Agreement"). The product may contain design defects or errors known as anomalies which may cause the product's functions to deviate from published specifications. Anomaly sheets are available upon request. SMSC products are not designed, intended, authorized or warranted for use in any life support or other application where product failure could cause or contribute to personal injury or severe property damage. Any and all such uses without prior written approval of an Officer of SMSC and further testing and/or modification will be fully at the risk of the customer. Copies of this document or other SMSC literature, as well as the Terms of Sale Agreement, may be obtained by visiting SMSC's website at http://www.smsc.com. SMSC is a registered trademark of Standard Microsystems Corporation ("SMSC"). Product names and company names are the trademarks of their respective holders.

The Microchip name and logo, and the Microchip logo are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SMSC DISCLAIMS AND EXCLUDES ANY AND ALL WARRANTIES, INCLUDING WITHOUT LIMITATION ANY AND ALL IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, TITLE, AND AGAINST INFRINGEMENT AND THE LIKE, AND ANY AND ALL WARRANTIES ARISING FROM ANY COURSE OF DEALING OR USAGE OF TRADE. IN NO EVENT SHALL SMSC BE LIABLE FOR ANY DIRECT, INCIDENTAL, INDIRECT, SPECIAL, PUNITIVE, OR CONSEQUENTIAL DAMAGES; OR FOR LOST DATA, PROFITS, SAVINGS OR REVENUES OF ANY KIND; REGARDLESS OF THE FORM OF ACTION, WHETHER BASED ON CONTRACT; TORT; NEGLIGENCE OF SMSC OR OTHERS; STRICT LIABILITY; BREACH OF WARRANTY; OR OTHERWISE; WHETHER OR NOT ANY REMEDY OF BUYER IS HELD TO HAVE FAILED OF ITS ESSENTIAL PURPOSE, AND WHETHER OR NOT SMSC HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

### **General Description**

SMSC's USB3370 is a family of Hi-Speed USB 2.0 Transceivers that provide a physical layer (PHY) solution well-suited for portable electronic devices. Both commercial and industrial temperature applications are supported.

Several advanced features make the USB3370 the transceiver of choice by reducing both eBOM part count and printed circuit board (PCB) area. Outstanding ESD robustness eliminates the need for external ESD protection devices in typical applications. The internal Over-Voltage Protection circuit (OVP) protects the USB3370 from voltages up to 30V on the **VBUS** pin. By using a reference clock from the Link, the USB3370 removes the cost of a dedicated crystal reference from the design. The USB3370 includes integrated 3.3V and 1.8V regulators, making it possible to operate the device from a single power supply.

The USB3370 is optimized for use in portable applications where a low operating current and standby currents are essential. The USB3370 operates from a single supply and includes integrated regulators for its supplies. The USB3370 also supports the USB Link Power Management protocol (LPM) to further reduce USB operating currents.

The USB3370 also includes family is enabled with SMSC's RapidCharge Anywhere<sup>TM</sup> which supports USB-IF Battery Charging 1.1 for any portable device. RapidCharge Anywhere<sup>TM</sup> provides three times the charging current through a USB port over traditional solutions which translate up to 1.5Amps via compatible USB host or dedicated charger. In addition, this provides a complete USB charging ecosystem between device and host ports such as Dedicated Charging Port (DCP), Charging (CDP) and Standard (SDP) Downstream Ports.

The USB3370 meets all of the electrical requirements for a Hi-Speed USB Host, Device, or an On-the-Go (OTG) transceiver. In addition to the supporting USB signaling, the USB3370 also provides USB UART mode.

USB3370 uses the industry standard UTMI+ Low Pin Interface (ULPI) to connect the USB transceiver to the Link. ULPI uses a method of in-band signaling and status byte transfers between the Link and PHY to facilitate a USB session with only twelve pins.

The USB3370 uses SMSC's "wrapper-less" technology to implement the ULPI interface. This "wrapper-less" technology allows the PHY to achieve a low latency transmit and receive time. SMSC's low latency transceiver allows an existing UTMI Link to be reused by adding a UTMI to ULPI bridge. By adding a bridge to the ASIC the existing and proven UTMI Link IP can be reused.

## **Block Diagram**

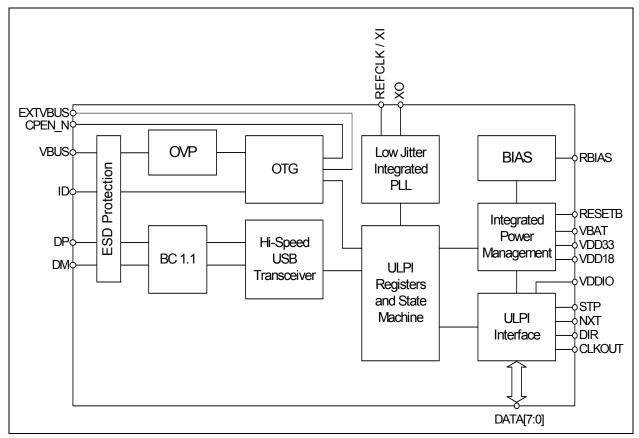


Figure 1 Block Diagram USB3370

PCB LAND PATTERN

uonug		utii	HG				
	COMMON DIMENSIONS  SYMBOL MIN NOM MAX NOTE REMARK					В	⊕ 0.10₩ C A B
SYMBOL	MIN	NOM	MAX	NOTE	REMARK	D	D2 — TERMINAL
А	0.70	0.85	1.00	-	OVERALL PACKAGE HEIGHT	D1 -	→ e → IDENTIFIE
A1	0	0.02	0.05	-	STANDOFF	32	32 AREA (D/2 X E/2)
A2	-	0.65	0.90	-	MOLD CAP THICKNESS	1	
D/E	4.90	5.00	5.10	-	X/Y BODY SIZE	3	Q 2 3 EVENESE
D1/E1	4.55	4.75	4.95	-	X/Y MOLD CAP SIZE	#/ /	EZ PAD (ePAL
D2/E2	3.20	3.30	3.40	-	X/Y EXPOSED PAD SIZE		
L	0.30	0.40	0.50	-	TERMINAL LENGTH	/II ! II	⊕
b	0.18	0.25	0.30	2	TERMINAL WIDTH		
k	0.35	0.45	-	-	TERMINAL TO ePAD CLEARANCE	4X 45°X0.6 MAX (OPTIONAL)	(DATUM A)
е		0.50 BSC		-	TERMINAL PITCH	TERMINAL #1 IDENTIFIER AREA	(DATUM B) 32X b 32X b 20.10  C A B
2. DIMENS BETWE 3. DETAIL	EN 0.15 AN	PPLIES TO D 0.30 mn INAL #1 II	O PLATED 1 FROM TI DENTIFIER	O TERMIN. HE TERM R ARE OP	ALS AND IT IS MEASURED INAL TIP. TIONAL BUT MUST BE LOCATED  0.2 - 0.3	TOP VIEW  SIDE VIEW	BOTTOM VIEW  3-D VIEWS
LANE SYMB GD/G D2/E X Y	E 4.00	MENSIONS  NOM MA  - 4.1  - 3.3  0.24 0.2  0.69 0.7	1. X 0 2. 8 3.	DESIGN AND EXPERIENC EXPOSED S CENTER PA MAXIMUM TO PERFORMAN	IAY MODIFY THE PCB LAND PATTERN  ) DIMENSIONS BASED ON THEIR  E AND/OR PROCESS CAPABILITY  OLDERABLE COPPER AREA OF THE  D CAN BE EITHER SOLID OR SEGMENTED  HERMAL AND ELECTRICAL PACKAGE  WCE IS ACHIEVED WHEN AN ARRAY OF  IS INCORPORATED IN THE CENTER LAND		

Enhanced Single Supply Hi-Speed USB ULPI Transceiver

Figure 2 USB3370 32-Pin QFN, 5x5mm Body, 0.5mm Pitch

### **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Microchip: USB3370B-EZK-TR